

1.5A, Ultra-High PSRR, Fast Load Transient, 1.2V Logic, Bias Rail CMOS Voltage Regulator

GENERAL DESCRIPTION

The SGM2077B is an ultra-high PSRR, fast transient response, low noise and low dropout voltage linear regulator which is designed using CMOS technology. It provides 1.5A output current capability. The operating input voltage range is from 0.5V to 5.5V and bias supply voltage range is from 2.5V to 5.5V. The adjustable output voltage range is from 0.5V to 3.3V.

Other features include 1.2V logic-controlled shutdown mode, short-circuit current limit and thermal shutdown protection. The SGM2077B has automatic discharge function to quickly discharge V_{OUT} in the disabled status.

The SGM2077B is available in a Green WLCSP-0.8×1.2-6B-B package. It operates over an operating temperature range of -40°C to +125°C.

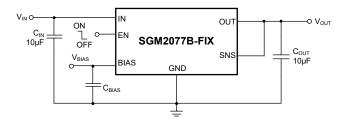
APPLICATIONS

Portable Equipment
Smartphone
Industrial and medical Equipment

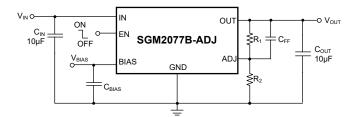
FEATURES

- Input Supply Voltage Range: 0.5V to 5.5V
- Bias Supply Voltage Range: 2.5V to 5.5V
- Fixed Outputs of 0.75V, 0.8V, 0.85V, 1.0V, 1.05V, 1.1V, 1.15V, 1.2V, 1.8V, 2.8V, 3.0V and 3.3V
- Adjustable Output from 0.5V to 3.3V
- 1.5A Output Current
- Output Voltage Accuracy: ±0.8% at +25°C
- Low Bias Input Current: 96μA (TYP)
- Low Dropout Voltage: 75mV (TYP) at 1.5A
- Low Noise: 29μV_{RMS} (TYP) at V_{OUT} = 1.1V
- High PSRR: 70dB (TYP) at 1kHz
- Current Limiting and Thermal Protection
- Excellent Load and Line Transient Responses
- With Output Automatic Discharge
- Stable with Small Case Size Ceramic Capacitors
- BIAS Pin Shutdown Current < 1μA
- UVLO with Hysteresis
- 1.2V Logic Level Enable Input for ON/OFF Control
- -40°C to +125°C Operating Temperature Range
- Available in a Green WLCSP-0.8×1.2-6B-B Package

TYPICAL APPLICATION



Fixed Voltage Typical Application Circuit



Adjustable Voltage Typical Application Circuit

Figure 1. Typical Application Circuits

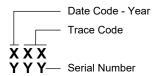


PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2077B-0.75	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-0.75XG/TR	XXX 0LC	Tape and Reel, 5000
SGM2077B-0.8	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-0.8XG/TR	XXX 0LD	Tape and Reel, 5000
SGM2077B-0.85	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-0.85XG/TR	XXX 0LE	Tape and Reel, 5000
SGM2077B-1.0	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-1.0XG/TR	XXX 0LF	Tape and Reel, 5000
SGM2077B-1.05	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-1.05XG/TR	XXX 0LG	Tape and Reel, 5000
SGM2077B-1.1	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-1.1XG/TR	XXX 0LH	Tape and Reel, 5000
SGM2077B-1.15	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-1.15XG/TR	XXX 0LI	Tape and Reel, 5000
SGM2077B-1.2	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-1.2XG/TR	XXX 0LJ	Tape and Reel, 5000
SGM2077B-1.8	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-1.8XG/TR	XXX 0LK	Tape and Reel, 5000
SGM2077B-2.8	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-2.8XG/TR	XXX 0LL	Tape and Reel, 5000
SGM2077B-3.0	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-3.0XG/TR	XXX 0LM	Tape and Reel, 5000
SGM2077B-3.3	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-3.3XG/TR	XXX 0LN	Tape and Reel, 5000
SGM2077B-ADJ	WLCSP-0.8×1.2-6B-B	-40°C to +125°C	SGM2077B-ADJXG/TR	XXX 0IA	Tape and Reel, 5000

MARKING INFORMATION

NOTE: XXX = Date Code and Trace Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

IN, BIAS, EN to GND0.3V to 6V
OUT, SNS, ADJ to GND0.3V to $Min(V_{IN} + 0.3V, 6V)$
Package Thermal Resistance
WLCSP-0.8×1.2-6B-B, θ_{JA} 95.7°C/W
WLCSP-0.8×1.2-6B-B, θ_{JB} 31°C/W
WLCSP-0.8×1.2-6B-B, θ_{JC}
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Lead Temperature (Soldering, 10s)+260°C
ESD Susceptibility
HBM5000V
CDM1000V

RECOMMENDED OPERATING CONDITIONS

Input Supply Voltage Range, V _{IN}	0.5V to 5.5V
Bias Supply Voltage Range, V _{BIAS}	2.5V to 5.5V
Bias Effective Capacitance, C _{BIAS}	0.1µF (MIN)
Input Effective Capacitance, C _{IN}	2.2µF (MIN)
Output Effective Capacitance, C _{OUT}	4.7µF to 22µF
Operating Junction Temperature Range	40°C to +125°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

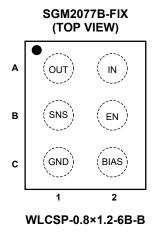
ESD SENSITIVITY CAUTION

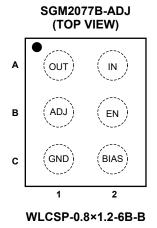
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS





PIN DESCRIPTION

PIN	NAME	FUNCTION
A1	OUT	Regulator Output Pin. It is recommended to use a ceramic capacitor with effective capacitance in the range of 4.7µF to 22µF to ensure stability. This ceramic capacitor should be placed as close as possible to OUT pin.
A2	IN	Input Voltage Supply Pin. It is recommended to use a 2.2µF or larger ceramic capacitor from IN pin to ground to get good power supply decoupling. This ceramic capacitor should be placed as close as possible to IN pin.
	SNS	Output Voltage Sense Input Pin (fixed voltage version only). Connect this pin to the load side of the output trace only in the fixed voltage version.
B1	ADJ	Feedback Input Pin (adjustable voltage version only). Connect this pin to the midpoint of an external resistor divider to adjust the output voltage. Place the resistors as close as possible to this pin.
B2	EN	Enable Pin. Drive EN high to turn on the regulator. Drive EN low to turn off the regulator. The EN pin has an internal 0.26µA pull-down current source.
C1	GND	Ground.
C2	BIAS	Bias Supply Voltage Pin for Internal Control Circuits. This pin is monitored by internal under-voltage lockout circuit.

FUNCTIONAL BLOCK DIAGRAMS

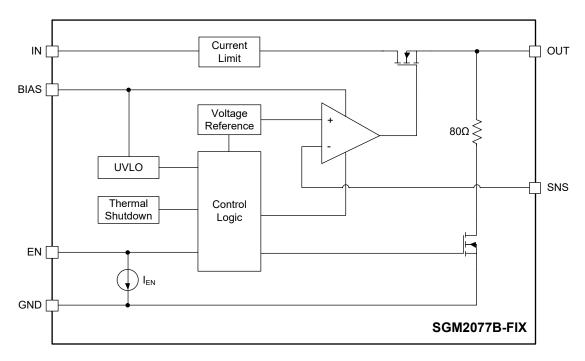


Figure 2. Fixed Output Voltage Internal Block Diagram

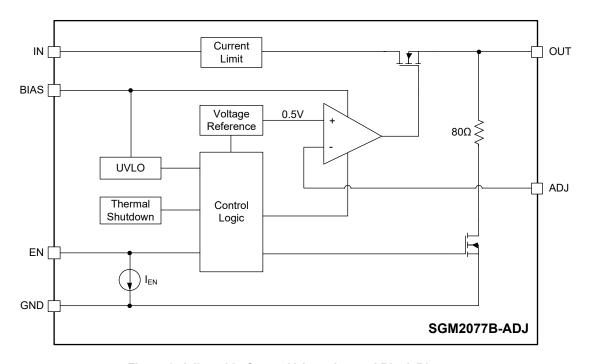


Figure 3. Adjustable Output Voltage Internal Block Diagram

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = V_{OUT(NOM)} + 0.3V, V_{BIAS} = 2.5V \text{ or } (V_{OUT(NOM)} + 1.6V) \text{ (whichever is greater)}, V_{EN} = 1V, I_{OUT} = 1mA, C_{IN} = 10\mu\text{F}, C_{OUT} = 10\mu\text{F}$ and $C_{BIAS} = 2.2\mu\text{F}, T_J = -40^{\circ}\text{C}$ to +125 $^{\circ}\text{C}$, typical values are at $T_J = +25^{\circ}\text{C}$, unless otherwise noted.)

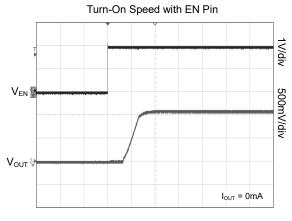
PARAMETER	SYMBOL	CONDI	TIONS	MIN	TYP	MAX	UNITS
Input Supply Voltage Range	V _{IN}			V _{OUT(NOM)} + V _{DROP VIN}		5.5	V
Bias Supply Voltage Range	V_{BIAS}			$(V_{OUT(NOM)} + 1.6) \ge 2.5$		5.5	V
Output Voltage Accuracy	V _{оит}	$V_{\text{IN}} = (V_{\text{OUT(NOM)}} + 0.3V) \text{ to} 5.5V, V_{\text{BIAS}} = 2.5V \text{ or} (V_{\text{OUT(NOM)}} + 1.6V) \text{ to } 5.5V, I_{\text{OUT}} = 1\text{mA} \text{ to } 1.5\text{A}$	$T_J = +25^{\circ}C$ $T_J = -40^{\circ}C \text{ to } +125^{\circ}C$	-0.8 -1.6		0.8 1.6	%
Feedback Voltage	V_{ADJ}	SGM2077B-ADJ		0.492		0.508	V
ADJ Pin Operating Current	I _{ADJ}			-10		10	nA
Under-Voltage Lockout	V_{UVLO}	V _{BIAS} rising Hysteresis			1.65 0.3	2	V
V _{IN} Line Regulation	$\frac{\Delta V_{\text{OUT}}}{\Delta V_{\text{IN}} \times V_{\text{OUT}}}$	$V_{IN} = (V_{OUT(NOM)} + 0.3V) \text{ to } 5.5$ $V_{IN} = (V_{OUT(NOM)} + 0.3V) \text{ to } 5.5$, ,		0.001	0.03	%/V
V _{BIAS} Line Regulation	$\frac{\Delta V_{\text{OUT}}}{\Delta V_{\text{BIAS}} \times V_{\text{OUT}}}$	$V_{BIAS} = 2.5V \text{ or } (V_{OUT(NOM)} + 0.5V \le V_{OUT(NOM)} \le 1.8V$ $V_{BIAS} = (V_{OUT(NOM)} + 1.6V) \text{ to}$	1.6V) to 5.5V,		0.02	0.1	%/V
Load Regulation	ΔV_{OUT}	$1.8V < V_{OUT(NOM)} \le 3.3V$ $I_{OUT} = 1 \text{mA to } 1.5 \text{A}$			1	6	mV
V _{IN} Dropout Voltage ⁽¹⁾	V _{DROP VIN}	I _{OUT} = 1.5A			75	130	mV
V _{BIAS} Dropout Voltage (2) (3)	V _{DROP BIAS}	I _{OUT} = 1.5A, V _{IN} = V _{BIAS}			1.15	1.4	V
Output Current Limit	I _{LIMIT}	$V_{OUT} = 90\% \times V_{OUT(NOM)}$		1.55	3		Α
Short-Circuit Current Limit	I _{SHORT}	V _{OUT} = 0V			1.1		Α
BIAS Pin Quiescent Current	I _{Q(BIAS)}	V _{BIAS} = 5.5V			96	135	μA
IN Pin Quiescent Current	$I_{Q(IN)}$	V _{IN} = 5.5V, I _{OUT} = 0mA			35	100	μA
BIAS Pin Shutdown Current	I _{SHDN(BIAS)}	V _{EN} = 0V				1	μΑ
IN Pin Shutdown Current	I _{SHDN(IN)}	$V_{EN} = 0V, T_{J} = +25^{\circ}C$ $V_{EN} = 0V$				0.5 8	μА
EN Pin High-Level Input Voltage	V _{IH}	Logic high, V _{BIAS} = 2.5V to	5.5V	0.73			V
EN Pin Low-Level Input Voltage	V _{IL}	Logic low, V _{BIAS} = 2.5V to 5	.5V			0.46	V
EN Pull-Down Current	I _{EN}	V _{EN} = 5.5V, V _{BIAS} = 5.5V			0.26	1	μA
Output Discharge Resistance	R _{DIS}	$V_{EN} = 0V, V_{OUT} = 0.5V$		50	80	120	Ω
Turn-On Time	t _{ON}	$V_{OUT(NOM)} = 1.1V$, from assertion of V_{EN} to V_{OUT}	= 98% × VOLITANOM		150		μs
V _{IN} Power Supply Rejection Ratio	PSRR	V_{IN} to V_{OUT} , $f = 1kHz$, $V_{OUT(N)}$ $I_{OUT} = 150mA$, $V_{IN} \ge 1.6V$	_{NOM)} = 1.1V,		70		dB
V _{BIAS} Power Supply Rejection Ratio	i ont	V_{BIAS} to V_{OUT} , $f = 1kHz$, V_{OU} $I_{OUT} = 150mA$, $V_{IN} \ge 1.6V$	_{T(NOM)} = 1.1V,		80		dB
Output Voltage Noise	e _n	V _{OUT(NOM)} = 1.1V, V _{IN} = 1.6V, f = 10Hz to 100kHz			29		μV_{RMS}
Thermal Shutdown Temperature	T_{SHDN}				160		°C
Thermal Shutdown Hysteresis	ΔT_{SHDN}				20		°C

NOTES:

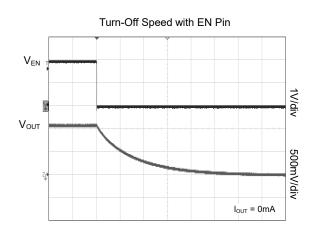
- 1. V_{IN} dropout voltage is defined as the difference between V_{IN} and V_{OUT} when V_{OUT} falls to 95% × $V_{OUT(NOM)}$.
- 2. V_{BIAS} dropout voltage refers to V_{BIAS} V_{OUT} when the IN and BIAS pins are connected together and V_{OUT} falls to 95% × V_{OUT(NOM)}.
- 3. For output voltages lower than 1.6V, V_{BIAS} dropout voltage is not applicable because the minimum bias supply voltage is 2.5V.

TYPICAL PERFORMANCE CHARACTERISTICS

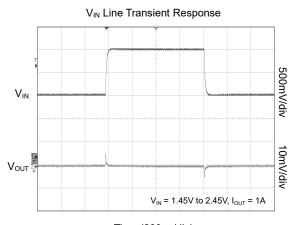
 $T_J = +25^{\circ}C$, $V_{IN} = 1.4V$, $V_{EN} = V_{BIAS} = 2.7V$, $V_{OUT(NOM)} = 1.1V$, $C_{IN} = 10\mu F$, $C_{OUT} = 10\mu F$, $C_{BIAS} = 2.2\mu F$, unless otherwise noted.



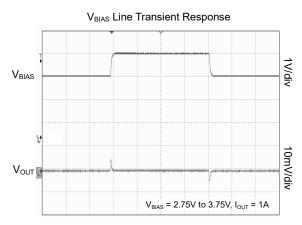




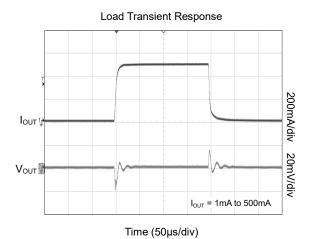
Time (500µs/div)

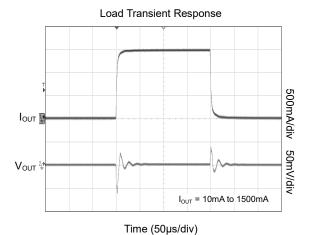


Time (200µs/div)



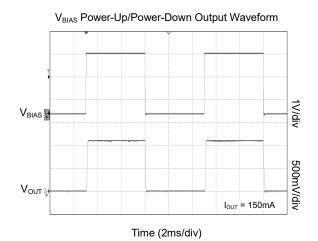
Time (200µs/div)

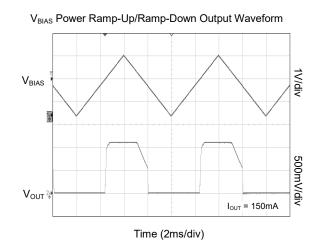


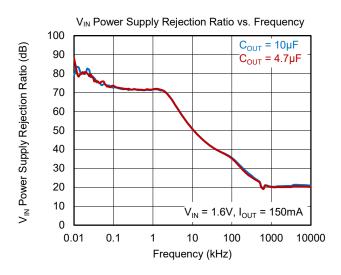


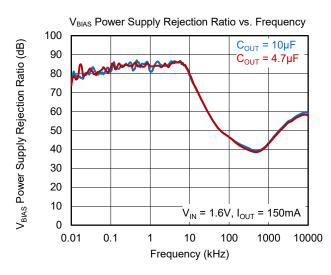
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

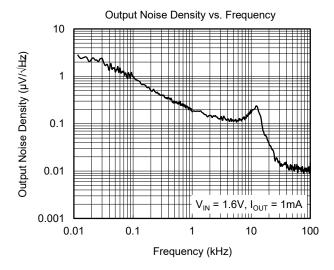
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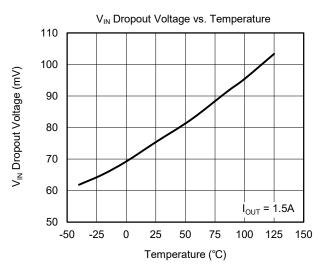






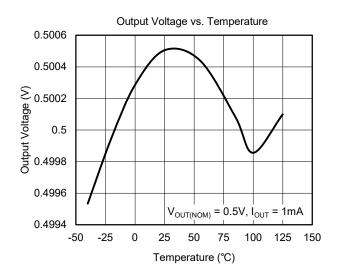


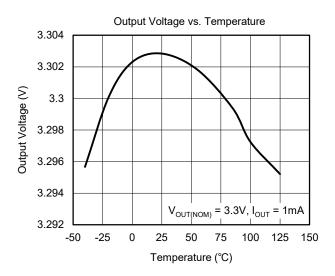


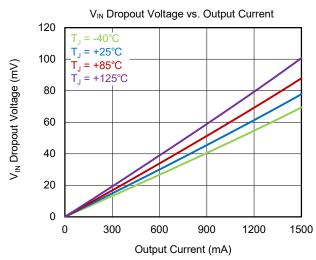


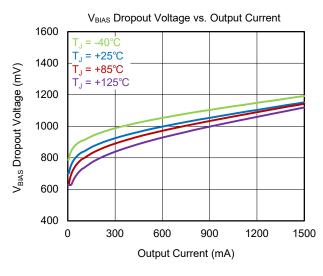
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

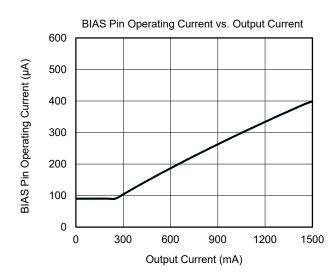
 $T_J = +25^{\circ}C$, $V_{IN} = 1.4V$, $V_{EN} = V_{BIAS} = 2.7V$, $V_{OUT(NOM)} = 1.1V$, $C_{IN} = 10\mu F$, $C_{OUT} = 10\mu F$, $C_{BIAS} = 2.2\mu F$, unless otherwise noted.

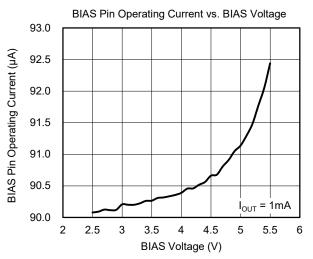












APPLICATION INFORMATION

The SGM2077B is an ultra-high PSRR, fast transient response high performance LDO. It consumes only $96\mu A$ (TYP) quiescent current and provides 1.5A output current. The SGM2077B provides the protection functions for output overload, output short-circuit condition and overheating.

The SGM2077B is suitable for application which has noise sensitive circuit such as battery-powered equipment and smartphones.

Input Capacitor Selection (C_{IN}/C_{BIAS})

The input decoupling capacitor should be placed as close as possible to the IN pin and BIAS pin to ensure the device stability. $C_{\text{IN}} = 2.2 \mu \text{F}/C_{\text{BIAS}} = 0.1 \mu \text{F}$ or larger X7R or X5R ceramic capacitors are selected to get good dynamic performance.

When V_{IN} is required to provide large current instantaneously, a large effective input capacitor is required. Multiple input capacitors can limit the input tracking inductance. Adding more input capacitors is available to restrict the ringing and to keep it below the device absolute maximum ratings.

Output Capacitor Selection (COUT)

The output capacitor should be placed as close as possible to the OUT pin. $10\mu F$ or greater X7R or X5R ceramic capacitor is selected to get good dynamic performance. The minimum effective capacitance of C_{OUT} that SGM2077B can remain stable is 4.7 μF . For ceramic capacitor, temperature, DC bias and package size will change the effective capacitance, so enough margin of C_{OUT} must be considered in design. Additionally, C_{OUT} with larger capacitance and lower ESR will help increase the high frequency PSRR and improve the load transient response.

Dropout Voltage

The SGM2077B specifies two dropout voltages because there are two power supplies V_{IN} and V_{BIAS} and one V_{OUT} regulator output. V_{IN} dropout voltage is

defined as the difference between V_{IN} and V_{OUT} when V_{OUT} falls 5% below $V_{\text{OUT}(\text{NOM})}$. When the output voltage is lower than 1.6V, V_{BIAS} dropout voltage is not applicable because the minimum bias supply voltage is 2.5V.

When V_{OUT} begins to decrease and V_{BIAS} is high enough, the V_{IN} dropout voltage equals to V_{IN} - V_{OUT} . V_{BIAS} dropout voltage refers to V_{BIAS} - V_{OUT} when the IN and BIAS pins are connected together and V_{OUT} begins to decrease.

Adjustable Regulator

The output voltage of the SGM2077B-ADJ can be adjusted from 0.5V to 3.3V. The ADJ pin will be connected to two external resistors as shown in Figure 4. The output voltage is determined by the following equation:

$$V_{OUT} = V_{ADJ} \times \left(1 + \frac{R_1}{R_2}\right) \tag{1}$$

where:

 V_{OUT} is output voltage and V_{ADJ} is the internal voltage reference, $V_{ADJ} = 0.5V$.

One parallel capacitor (C_{FF}) with R_1 can be used to improve the feedback loop stability and PSRR, increase the transient response and reduce the output noise. Use $R_2 \leq 10 k\Omega$ with C_{FF} in the range of 1nF to 100nF (effective capacitance), or choose $R_2 \leq 1.5 k\Omega$ and the value of C_{FF} is unlimited.

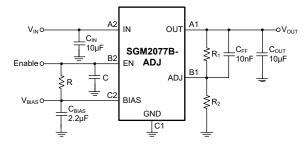


Figure 4. Adjustable Output Voltage Application

APPLICATION INFORMATION (continued)

Enable Operation

The EN pin of the SGM2077B is used to enable/disable the device and to deactivate/activate the output automatic discharge function.

When the EN pin voltage is lower than 0.46V, the device is in shutdown state. There is no current flowing from IN to OUT pins. In this state, the automatic discharge transistor is active to discharge the output voltage through an 80Ω (TYP) resistor.

When the EN pin voltage is higher than 0.73V, the device is in active state. The output voltage is regulated to the expected value and the automatic discharge transistor is turned off. It is recommended that the rising and falling edge speeds of EN be faster than $100\mu s/V$. Slow edge speeds may cause the output to repeatedly turn on and off.

The EN pin is pulled down by internal $0.26\mu A$ (TYP) current source when the EN pin is floated. This current source will ensure the SGM2077B in shutdown state and reduce the power dissipation in system.

Reverse Current Protection

The NMOS power transistor has an inherent body diode, this body diode will be forward biased when $V_{\text{OUT}} > V_{\text{IN}}$. When $V_{\text{OUT}} > V_{\text{IN}}$, the reverse current flowing from the OUT pin to the IN pin will damage the SGM2077B. If $V_{\text{OUT}} > (V_{\text{IN}} + 0.3 \text{V})$ event would happen in system, one external Schottky diode will be added between the OUT pin and IN pin in circuit design to protect the SGM2077B.

Negatively Biased Output

When the output voltage is negative, the chip may not start up due to parasitic effects. Ensure that the output is greater than -0.3V under all conditions. If negatively

biased output is excessive and expected in the application, a Schottky diode can be added between the OUT pin and GND pin.

Output Current Limit and Short-Circuit Protection

When overload events happen, the output current is internally limited to 3A (TYP). When the OUT pin is shorted to ground, the short-circuit protection will limit the output current to 1.1A (TYP).

Thermal Shutdown Protection

The SGM2077B can detect the temperature of die. When the die temperature exceeds the threshold value of thermal shutdown, the SGM2077B will be in shutdown state and it will remain in this state until the die temperature decreases to +140°C.

Power Dissipation (P_D)

Power dissipation (P_D) of the SGM2077B can be calculated by the equation $P_D = (V_{IN} - V_{OUT}) \times I_{OUT}$. The maximum allowable power dissipation ($P_{D(MAX)}$) of the SGM2077B is affected by many factors, including the difference between junction temperature and ambient temperature ($T_{J(MAX)} - T_A$), package thermal resistance from the junction to the ambient environment (θ_{JA}), the rate of ambient airflow and PCB layout. $P_{D(MAX)}$ can be approximated by the following equation:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$$
 (2)

The power dissipation needs to be less than 6W when thermal protection occurs. The power dissipation must be less than 6W for the device protection. For example, when output is short to GND, the short current is about 2A and the input voltage must be less than 3V, otherwise the SGM2077B may be damaged.

REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

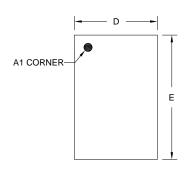
Changes from Original (SEPTEMBER 2023) to REV.A

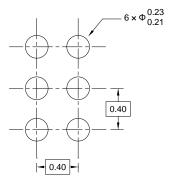
Page

Changed from product preview to production data.....



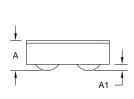
PACKAGE OUTLINE DIMENSIONS WLCSP-0.8×1.2-6B-B

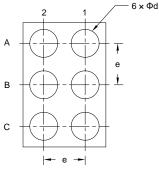




TOP VIEW

RECOMMENDED LAND PATTERN (Unit: mm)





SIDE VIEW

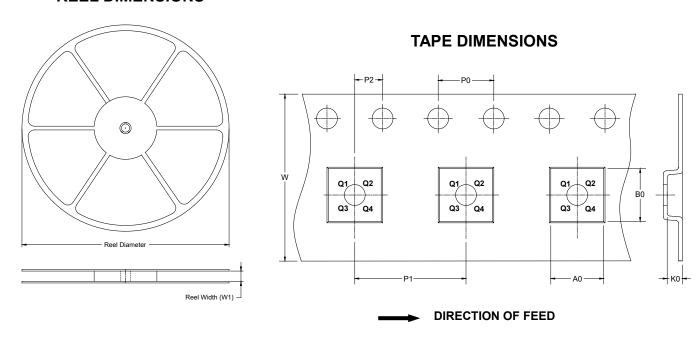
BOTTOM VIEW

Symbol	Dimensions In Millimeters						
Symbol	MIN	MOD	MAX				
Α	0.262	0.290	0.318				
A1	0.050	0.060	0.070				
D	0.780	0.805	0.830				
E	1.180	1.205	1.230				
d	0.250	0.290					
е	0.400 BSC						

NOTE: This drawing is subject to change without notice.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

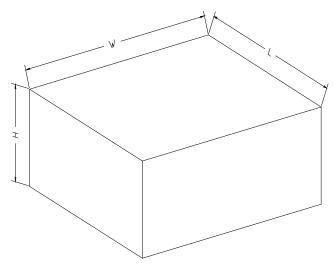


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
WLCSP-0.8×1.2-6B-B	7"	9.5	0.90	1.30	0.42	4.0	4.0	2.0	8.0	Q1

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18